

Silicon Carbide Diode 24 August 2018

**Product data sheet** 

# 1. General description

Silicon Carbide Schottky diode in a TO220F-2L plastic package, designed for high frequency switched-mode power supplies.

# 2. Features and benefits

- Highly stable switching performance
- High forward surge capability I<sub>FSM</sub>
- Extremely fast reverse recovery time
- Superior in efficiency to Silicon Diode alternatives
- Reduced losses in associated MOSFET
- Reduced EMI
- Reduced cooling requirements
- RoHS compliant
- Insulated package rated at 2500V RMS

# 3. Applications

- Power factor correction
- Telecom / Server SMPS
- UPS
- PV inverter
- PC Silverbox
- LED / OLED TV
- Motor Drives

# 4. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>RRM</sub>	repetitive peak reverse voltage		-	-	650	V
I <sub>F(AV)</sub>	average forward current	$\delta$ = 0.5 ; T <sub>h</sub> ≤ 104 °C; square-wave pulse; Fig. 1; Fig. 2; Fig. 3; Fig. 4	-	-	4	A
Static chara	acteristics	·				
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 4 A; T <sub>j</sub> = 25 °C; <u>Fig. 6</u>	-	1.5	1.7	V
		I <sub>F</sub> = 4 A; T <sub>j</sub> = 150 °C; <u>Fig. 6</u>	-	1.8	2.1	V

# 5. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	К	cathode	٦	K – K – A
2	А	anode	© <b>O</b> ⊚	001aaa020
mb	n.c.	mounting base; isolated	TO220F-2L	

# 6. Ordering information

Table 3. Ordering information							
Type number	Package						
	Name	Description	Version				
NXPSC04650X	-	Plastic single-ended through-hole package; isolated heatsink mounted; 1 mounting hole; 2-lead TO-220F	TO220F-2L				

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## 7. Limiting values

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>RRM</sub>	repetitive peak reverse voltage		-	650	V
V <sub>RWM</sub>	crest working reverse voltage		-	650	V
V <sub>R</sub>	reverse voltage	DC	-	650	V
I <sub>F(AV)</sub>	average forward current	$\begin{array}{l} \delta = 0.5 \hspace{0.2cm} ; \hspace{0.2cm} T_h \leq \hspace{0.2cm} 104 \hspace{0.2cm} ^{\circ}C; \hspace{0.2cm} square-wave \hspace{0.2cm} pulse; \\ \hline Fig. \hspace{0.2cm} 1; \hspace{0.2cm} Fig. \hspace{0.2cm} 2; \hspace{0.2cm} Fig. \hspace{0.2cm} 3; \hspace{0.2cm} Fig. \hspace{0.2cm} 4 \end{array}$	-	4	A
I <sub>FRM</sub>	repetitive peak forward current	$\delta$ = 0.5 $\ ; t_p$ = 25 µs; $T_h \leq \ 104 \ ^\circ C;$ squarewave pulse	-	8	A
I <sub>FSM</sub>	non-repetitive peak	$t_p$ = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	-	24	А
	forward current	t <sub>p</sub> = 10 μs; T <sub>j(init)</sub> = 25 °C; square-wave pulse	-	235	A
T <sub>stg</sub>	storage temperature		-55	175	°C
Tj	junction temperature		-	175	°C

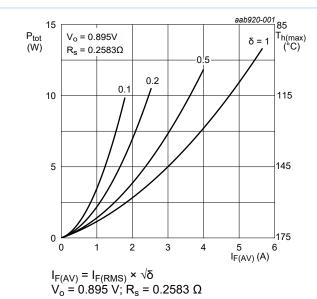
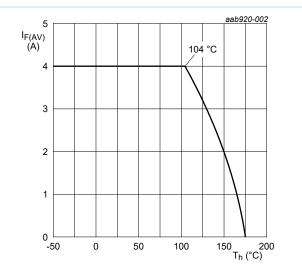


Fig. 1. Forward power dissipation as a function of average forward current; square waveform; maximum values

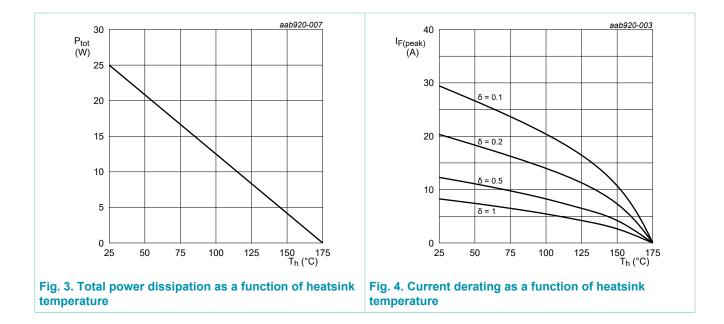




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# NXPSC04650X

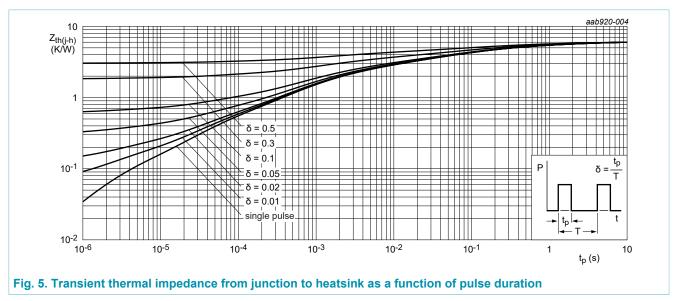
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### 8. Thermal characteristics

Table 5. Therma	al characteristics		 			
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R <sub>th(j-h)</sub>	thermal resistance from junction to heatsink	with heatsink compound; Fig. 5	-	-	6	K/W
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient free air	in free air	-	55	-	K/W



# 9. Isolation characteristics

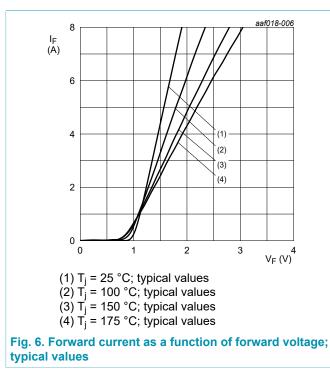
Table 6. Isolation characteristics							
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V <sub>isol(RMS)</sub>	RMS isolation voltage	from all terminals to external heatsink; sinusoidal waveform; clean and dust free; 50 Hz $\leq$ f $\leq$ 60 Hz; T <sub>h</sub> = 25 °C; RH $\leq$ 65 %		-	-	2500	V

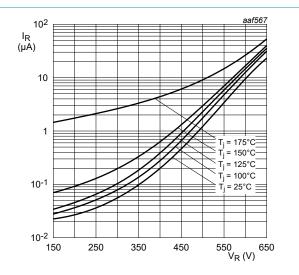
### Table 5 Thermal characteristics

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### **10. Characteristics**

Table 7. Cha	aracteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	acteristics					
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 4 A; T <sub>j</sub> = 25 °C; <u>Fig. 6</u>	-	1.5	1.7	V
		I <sub>F</sub> = 4 A; T <sub>j</sub> = 150 °C; <u>Fig. 6</u>	-	1.8	2.1	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = 600 V; T <sub>j</sub> = 25 °C; <u>Fig. 7</u>	-	-	85	μA
		V <sub>R</sub> = 600 V; T <sub>j</sub> = 150 °C; <u>Fig. 7</u>	-	-	340	μA
		V <sub>R</sub> = 650 V; T <sub>j</sub> = 25 °C; <u>Fig. 7</u>	-	-	170	μA
		V <sub>R</sub> = 650 V; T <sub>j</sub> = 150 °C; <u>Fig. 7</u>	-	-	550	μA
Dynamic ch	naracteristics	· · ·				_
Q <sub>r</sub>	recovered charge	I <sub>F</sub> = 4 A; dI <sub>F</sub> /dt = 500 A/μs; V <sub>R</sub> = 400 V; T <sub>j</sub> = 25 °C; <u>Fig. 8</u>	-	7	-	nC
C <sub>d</sub>	diode capacitance	f = 1 MHz; V <sub>R</sub> = 1 V; T <sub>j</sub> = 25 °C	-	130	-	pF
		f = 1 MHz; V <sub>R</sub> = 300 V; T <sub>j</sub> = 25 °C	-	16	-	pF
		f = 1 MHz; V <sub>R</sub> = 600 V; T <sub>i</sub> = 25 °C	-	13	-	pF



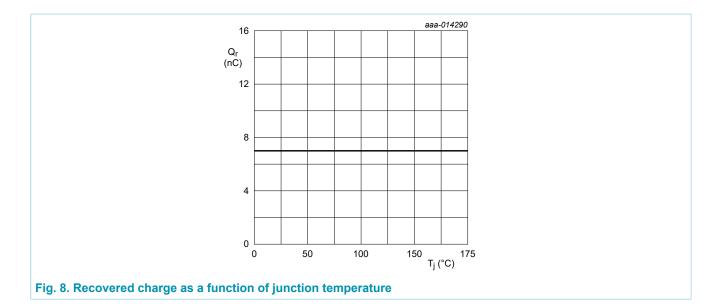




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## 11. Package outline

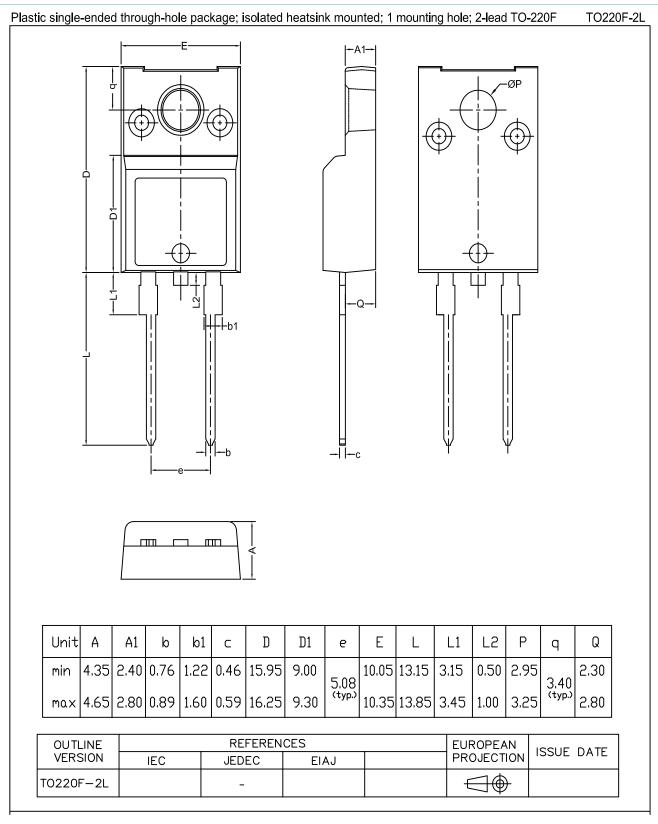


Fig. 9. Package outline TO220F-2L

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## 12. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [ <u>3]</u>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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